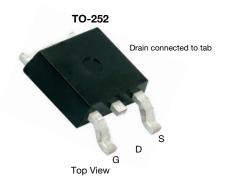
SQD40131EL

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Vishay Siliconix

Automotive P-Channel 40 V (D-S) 175 °C MOSFET

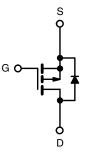


| PRODUCT SUMMARY | | | | |
|--|--------|--|--|--|
| V _{DS} (V) | -40 | | | |
| $R_{DS(on)}$ (Ω) at V_{GS} = -10 V | 0.0115 | | | |
| $R_{DS(on)}\left(\Omega\right)$ at V_{GS} = -4.5 V | 0.0150 | | | |
| I _D (A) | -50 | | | |
| Configuration | Single | | | |
| Package | TO-252 | | | |

FEATURES

- TrenchFET[®] power MOSFET
- · Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>





P-Channel MOSFET

| ABSOLUTE MAXIMUM RATING | S (T _C = 25 °C, unless | otherwise noted | ł) | | |
|---|--|-----------------------------------|-------------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Drain-source voltage | | V _{DS} | -40 | V | |
| Gate-source voltage | | V _{GS} | ± 20 | v | |
| Continuous drain current | T _C = 25 °C ª | - I _D | -50 | | |
| | T _C = 125 °C | | -31 | | |
| Continuous source current (diode conduction) ^a | | IS | -50 | А | |
| Pulsed drain current ^b | | I _{DM} | -180 | | |
| Single pulse avalanche current | L = 0.1 mH | I _{AS} | -27 | | |
| Single pulse avalanche energy | | E _{AS} | 36.4 | mJ | |
| Manimum manual disain stick b | T _C = 25 °C | D | 62 | W | |
| Maximum power dissipation ^b | T _C = 125 °C | P _D | 20 | vv | |
| Operating junction and storage temperature | range | T _J , T _{stg} | -55 to +175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | |
|----------------------------|------------------------|-------------------|-------|------|--|
| PARAMETER | | SYMBOL | LIMIT | UNIT | |
| Junction-to-ambient | PCB mount ^c | R _{thJA} | 50 | °C/W | |
| Junction-to-case (drain) | | R _{thJC} | 2.4 | C/W | |

Notes

a. Package limited

b. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

c. When mounted on 1" square PCB (FR4 material)

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| PARAMETER | SYMBOL | TES | MIN. | TYP. | MAX. | UNIT | | |
|--|------------------------|---|---|------|--------|--------|----|--|
| Static | | <u>.</u> | | | • | • | | |
| Drain-source breakdown voltage | V _{DS} | $V_{GS} = 0 V, I_D = -250 \ \mu A$ | | -40 | - | - | v | |
| Gate-source threshold voltage | V _{GS(th)} | V _{DS} = | $V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$ | | -2 | -2.5 | | |
| Gate-source leakage | I _{GSS} | V _{DS} = | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | - | ± 100 | nA | |
| | | $V_{GS} = 0 V$ | V _{DS} = -40 V | - | - | -1 | | |
| Zero gate voltage drain current | I _{DSS} | $V_{GS} = 0 V$ | V _{DS} = -40 V, T _J = 125 °C | - | - | -50 | μA | |
| | | $V_{GS} = 0 V$ | V _{DS} = -40 V, T _J = 175 °C | - | - | -250 | 1 | |
| On-state drain current ^a | I _{D(on)} | $V_{GS} = -10 \text{ V}$ | $V_{DS} \ge 5 V$ | -30 | - | - | Α | |
| | | $V_{GS} = -10 V$ | I _D = -30 A | - | 0.0095 | 0.0115 | 1 | |
| Duraina a successive and a state marciata a second | P | V _{GS} = -10 V | I _D = -30 A, T _J = 125 °C | - | - | 0.0171 | Ω | |
| Drain-source on-state resistance ^a | R _{DS(on)} | $V_{GS} = -10 \text{ V}$ | I _D = -30 A, T _J = 175 °C | - | - | 0.0203 | | |
| | | $V_{GS} = -4.5 V$ | I _D = -25 A | - | 0.0121 | 0.0150 | | |
| Forward transconductance ^b | 9 _{fs} | V _{DS} = | -15 V, I _D = -30 A | - | 71 | - | S | |
| Dynamic ^b | | <u>.</u> | | | | | | |
| Input capacitance | C _{iss} | | | - | 4872 | 6600 | | |
| Output capacitance | C _{oss} | $V_{GS} = 0 V$ | V _{DS} = -25 V, f = 1 MHz | - | 344 | 500 | pF | |
| Reverse transfer capacitance | C _{rss} | | | - | 316 | 450 | | |
| Total gate charge ^c | Qg | | | - | 76 | 115 | nC | |
| Gate-source charge ^c | Q_gs | V _{GS} = -10 V | $V_{DS} = -20 \text{ V}, \text{ I}_{D} = -30 \text{ A}$ | - | 11.5 | - | | |
| Gate-drain charge ^c | Q _{gd} | | | - | 13.5 | - | | |
| Gate resistance | R _g | | f = 1 MHz | 2 | 4 | 6 | Ω | |
| Turn-on delay time ^c | t _{d(on)} | | | - | 13 | 20 | | |
| Rise time ^c | t _r | V _{DD} = | V_{DD} = -20 V, R _L = 0.7 Ω I _D \cong -30 A, V _{GEN} = -10 V, R _g = 1 Ω | | 7 | 15 | 1 | |
| Turn-off delay time ^c | t _{d(off)} | I _D ≅ -30 A, | | | 66 | 100 | ns | |
| Fall time ^c | t _f | | | | 28 | 45 | | |
| Source-Drain Diode Ratings and Charac | teristics ^b | | | | | | | |
| Pulsed current ^a | I _{SM} | | | | - | -180 | Α | |
| Forward voltage | V _{SD} | I _F = -30 A, V _{GS} = 0 V | | - | -0.9 | -1.5 | V | |
| Body diode reverse recovery time | t _{rr} | - I _F = -30 A, di/dt = 100 A/μs | | - | 43 | 90 | ns | |
| Body diode reverse recovery charge | Q _{rr} | | | - | 45 | 100 | nC | |
| Reverse recovery fall time | t _a | | | - | 26 | - | İ | |
| Reverse recovery rise time | t _b | | | - | 17 | - | ns | |
| Body diode peak reverse recovery current | I _{RM(REC)} | + | | | -2.8 | - | Α | |

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

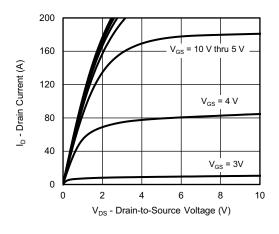
2



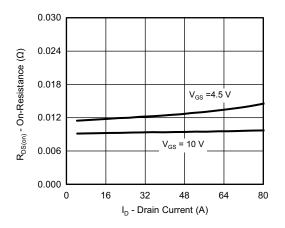
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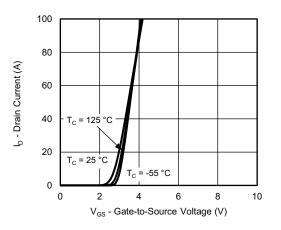
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



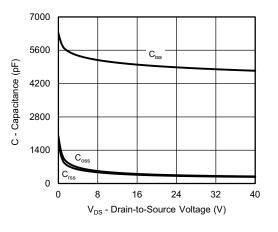
Output Characteristics



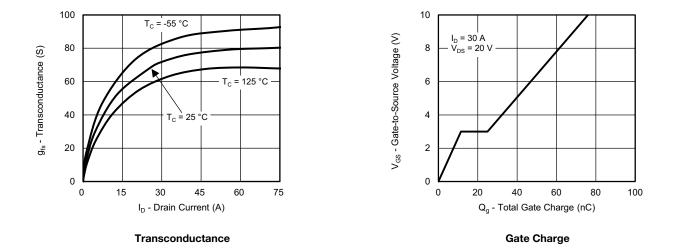
On-Resistance vs. Drain Current



Transfer Characteristics



Capacitance



S17-1302-Rev. A, 21-Aug-17

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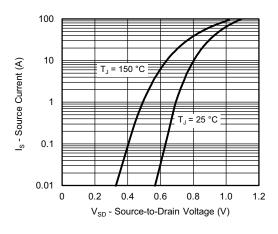
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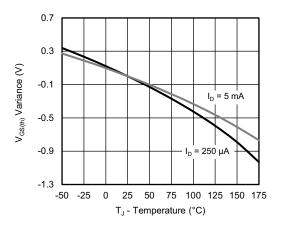


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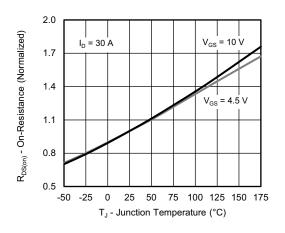
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



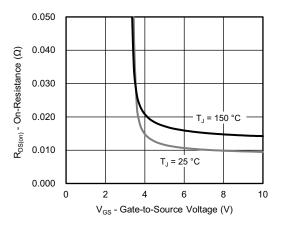
Source Drain Diode Forward Voltage



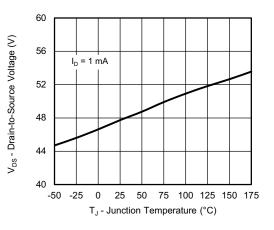
Threshold Voltage



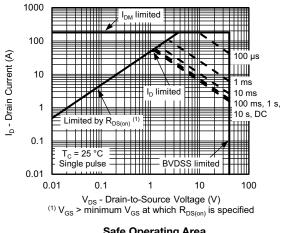
On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage



Drain Source Breakdown vs. Junction Temperature



Safe Operating Area

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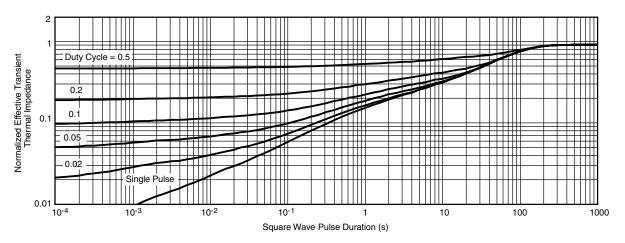
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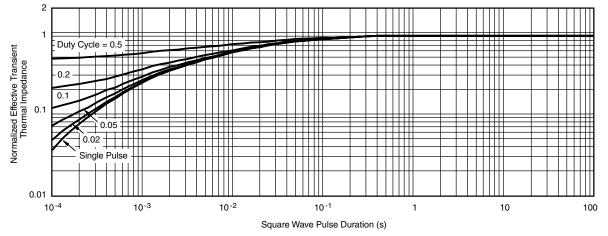


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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
- Normalized Transient Thermal Impedance Junction to Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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| S17-1302-Rev. A, 21-Aug-17 | 5 | Document Number: 76864 |
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Е b3 Ľ Δ ŝ b2 e1 Б E1

C2 т gage plane height (0.5 mm)

-C

- A1

TO-252AA Case Outline

| | MILLIMETERS | | INC | HES | |
|--|-------------|------------------|--------------------|-------|--|
| DIM. | MIN. | MAX. | MIN. | MAX. | |
| А | 2.18 | 2.38 | 0.086 | 0.094 | |
| A1 | - | 0.127 | - | 0.005 | |
| b | 0.64 | 0.88 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| C2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | |
| D1 | 4.10 | - | 0.161 | - | |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | |
| E1 | 4.32 | - | 0.170 | - | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| е | 2.28 BSC | | 2.28 BSC 0.090 BSC | | |
| e1 | 4.56 | 4.56 BSC 0.180 B | | BSC | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.01 | 1.52 | 0.040 | 0.060 | |
| ECN: T13-0592-Rev. A, 02-Sep-13 DWG: 6019 | | | | | |

Note

• Dimension L3 is for reference only.





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RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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